

Docket No. N1085-00040
Inventor: Ming-Shuoh Liang et al.
"A Method Of Providing Via In A Multilayer Semiconductor Device
Sheet 1 of 6

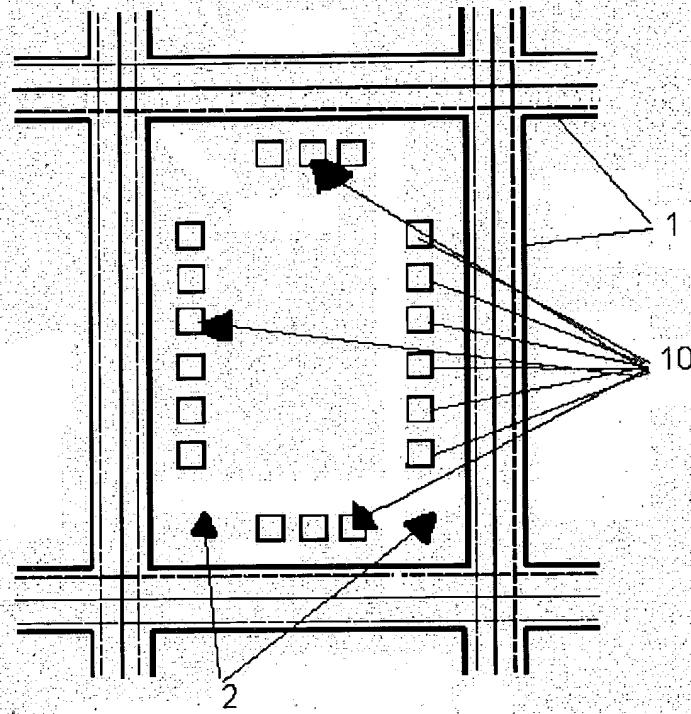


FIG. 1

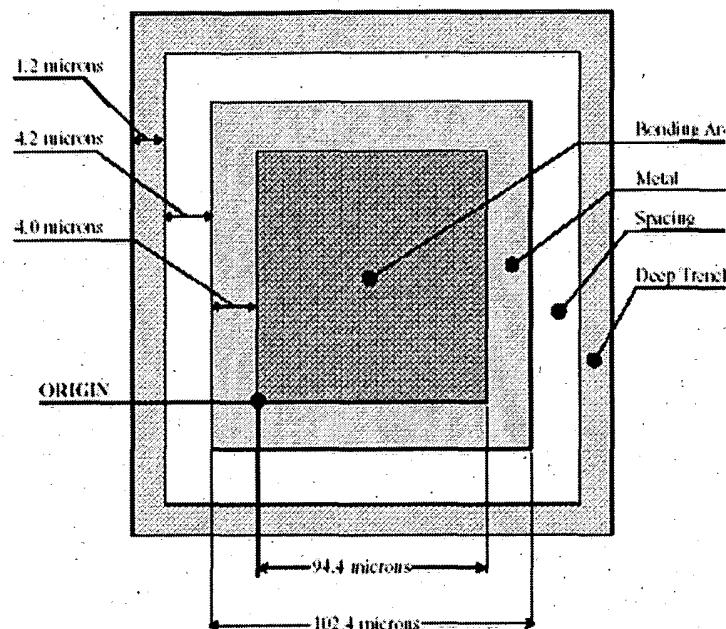


FIG. 2a

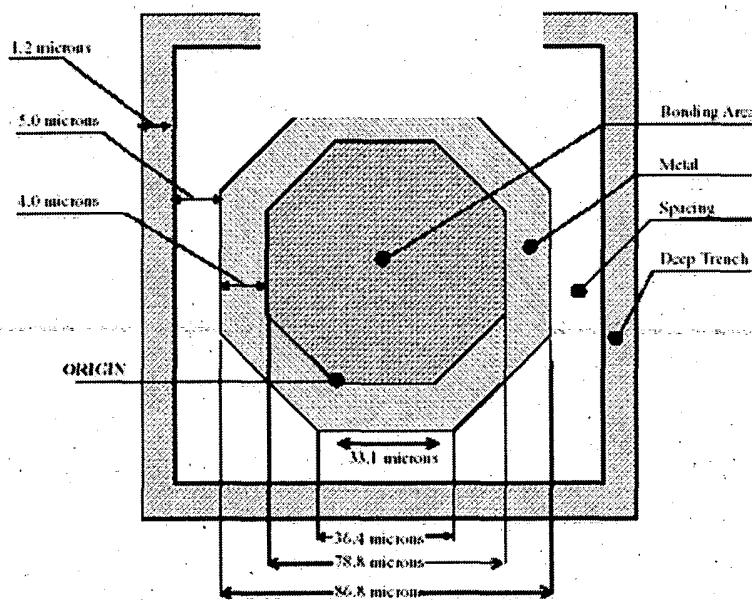


FIG. 2b

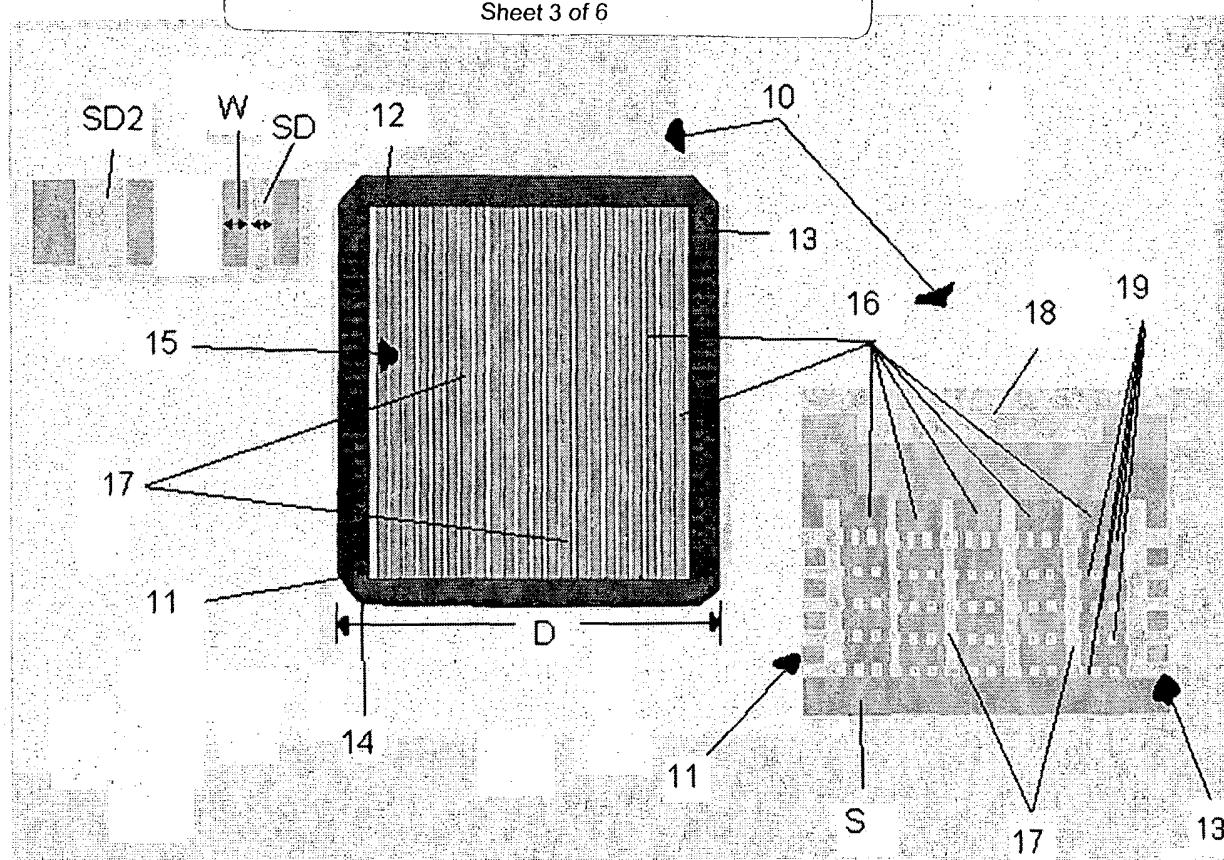


FIG. 3a

FIG. 3b

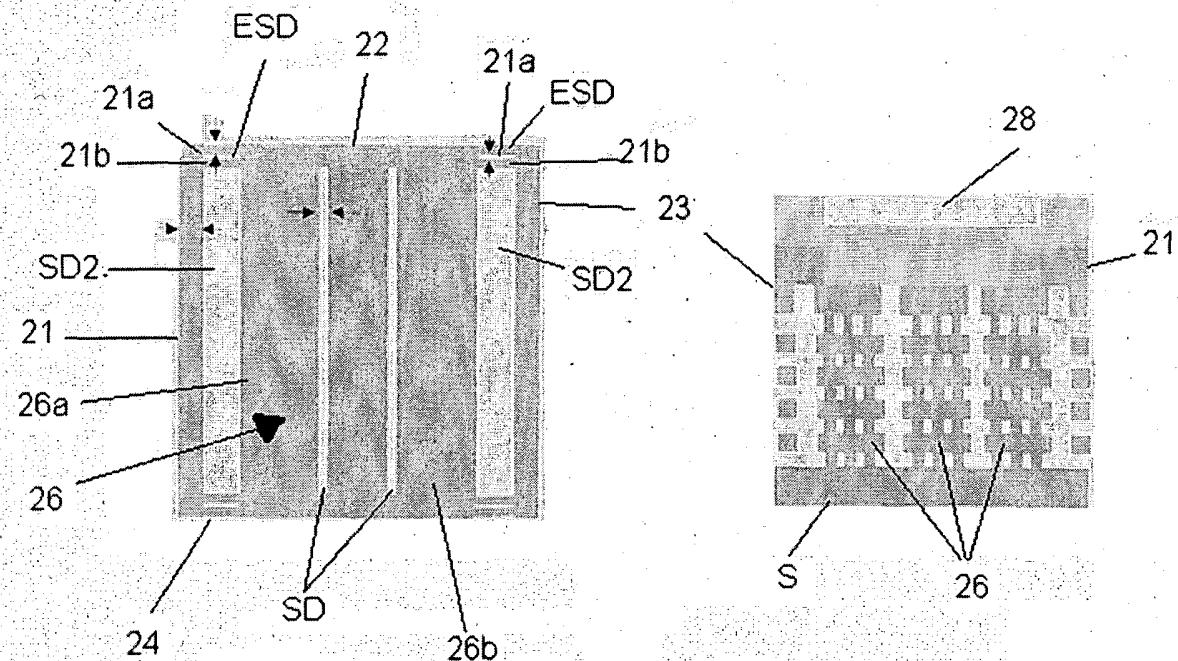


FIG. 4a

FIG. 4b

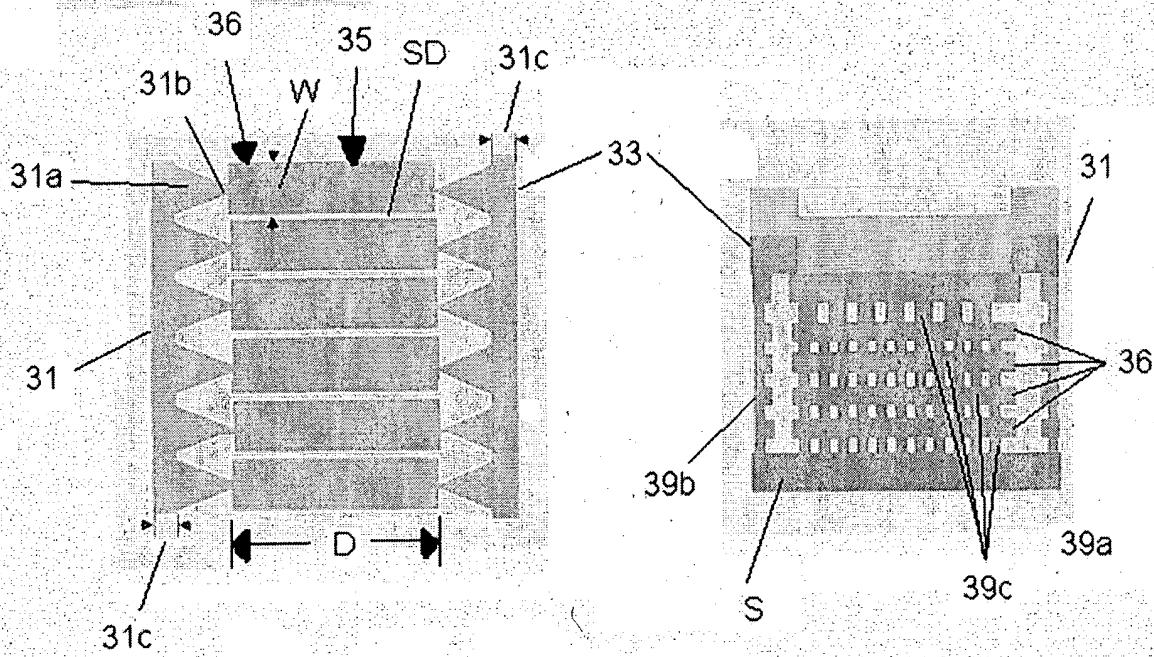


FIG. 5b

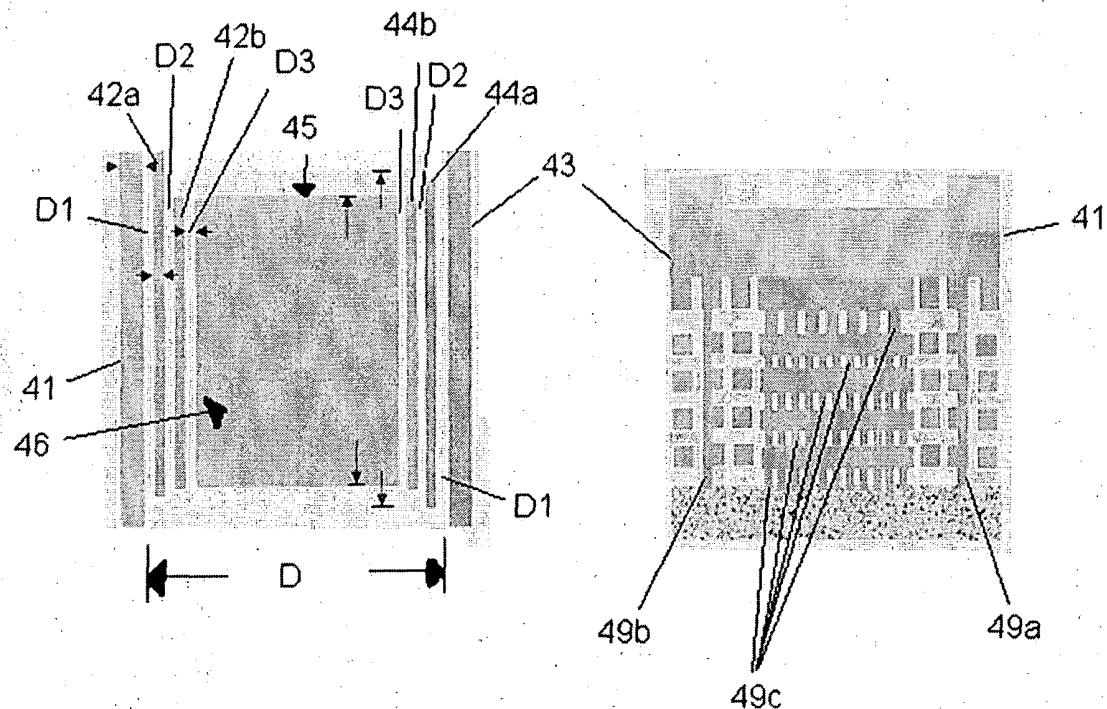


FIG. 6a

FIG. 6b